

# SKM 214A



**SEMITRANS™ 2**

## Power MOSFET Modules

**SKM 214 A**

### Features

- N Channel, enhancement mode
- Avalanche characteristic
- Short internal connections avoid oscillations
- Isolated copper baseplate
- All electrical connections on top for easy busbaring
- Large clearances (10 mm) and creepage distances (20 mm)
- UL recognized, file no. E 63 532

### Typical Applications

- Switched mode power supplies
- DC servo and robot drives
- DC choppers
- UPS equipment
- Not suitable for linear amplification



**MB**

Absolute Maximum Ratings		$T_c = 25^\circ\text{C}$ , unless otherwise specified	
Symbol	Conditions	Values	Units
$V_{DS}$		100	V
$I_D$	$T_s = 25 (80)^\circ\text{C}$	125 (95)	A
$I_{DM}$	1 ms	375	A
$V_{GS}$		$\pm 20$	V
$T_{vj}$ ( $T_{stg}$ )		- 40 ... +150 (125)	$^\circ\text{C}$
$V_{isol}$	AC, 1 min.	2500	V
Inverse diode			
$I_F = -I_S$		125	A
$I_{FM} = -I_{SM}$		375	A

Characteristics		$T_c = 25^\circ\text{C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 0,25\text{ mA}$	100			V
$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 1\text{ mA}$	2,1	3	4	V
$I_{DSS}$	$V_{GS} = 0\text{ V}, V_{DS} = 100\text{ V}, T_j = 25 (125)^\circ\text{C}$		50 (300)	250 (1000)	$\mu\text{A}$
$I_{GSS}$	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$		10	100	nA
$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 78\text{ A}$		10	13	$\text{m}\Omega$
$g_{fs}$	$V_{DS} = 25\text{ V}, I_D = 78\text{ A}$	40	60		S
$C_{CHC}$	$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$			100	pF
$C_{iss}$			9	12	nF
$C_{oss}$			4	6	nF
$C_{rss}$			1,6	2,4	nF
$L_{DS}$				20	nH
$t_{d(on)}$	$V_{DD} = 50\text{ V}, I_D = 78\text{ A}, V_{GS} = 10\text{ V}, R_G = 3,3\ \Omega$		50		ns
$t_r$			190		ns
$t_{d(off)}$			190		ns
$t_f$			50		ns
Inverse diode					
$V_{SD}$	$I_F = 250\text{ A}; V_{GS} = 0\text{ V}$		1,25	1,6	V
$t_{rr}$	$T_j = 25 (150)^\circ\text{C}$		320		ns
$Q_{rr}$	$T_j = 25^\circ\text{C}$		3,6		$\mu\text{C}$
$I_{rr}$	$T_j = 150^\circ\text{C}$				A
Thermal characteristics					
$R_{th(j-c)}$	per MOSFET			0,31	K/W
$R_{th(c-s)}$	$M_s$ , surface, per module			0,07	K/W
Mechanical data					
$M_s$	to heatsink (M6)	4		5	Nm
$M_t$	for terminals (M5)	2,5		3,5	Nm
w		160			g

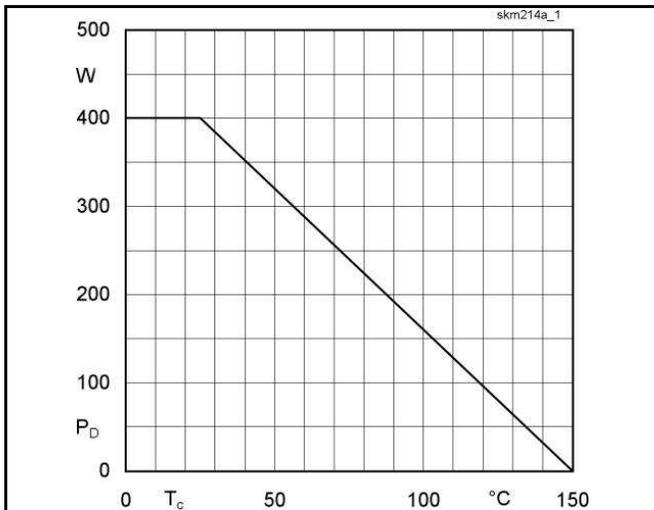


Fig. 1 Rated power dissipation vs. temperature

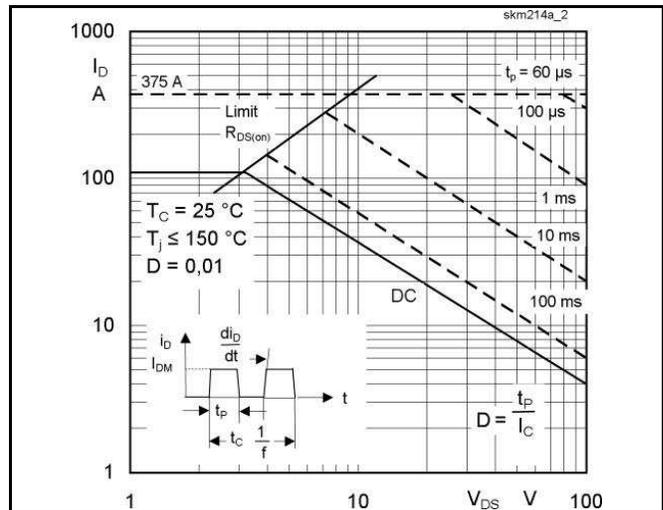


Fig. 2 Maximum safe operating area

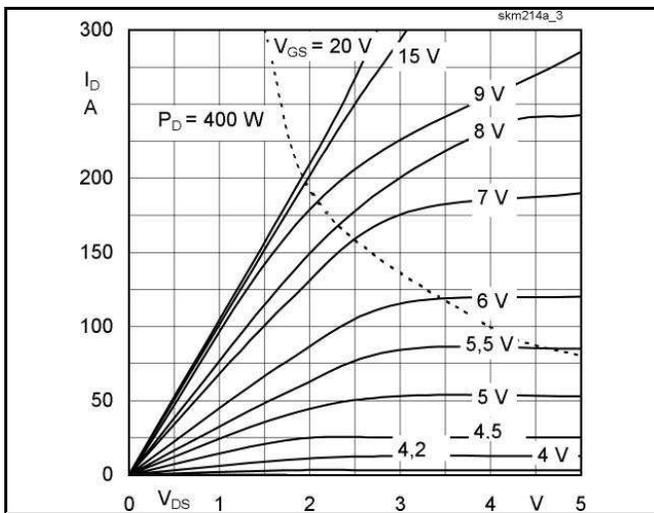


Fig. 3 Output characteristic

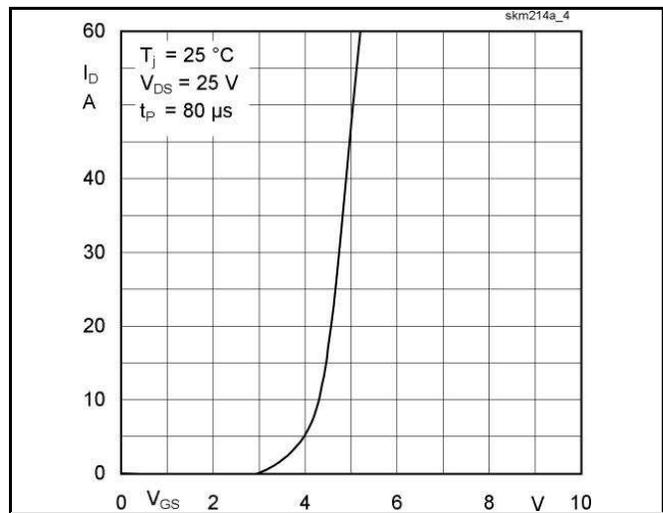


Fig. 4 Transfer characteristic

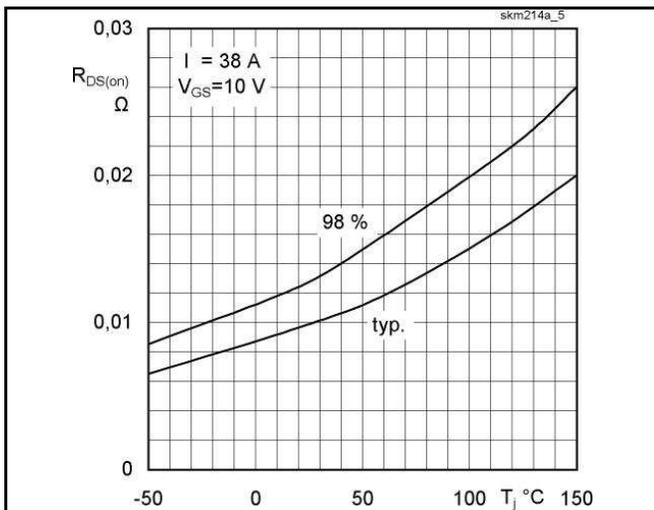


Fig. 5 On-resistance vs. temperature

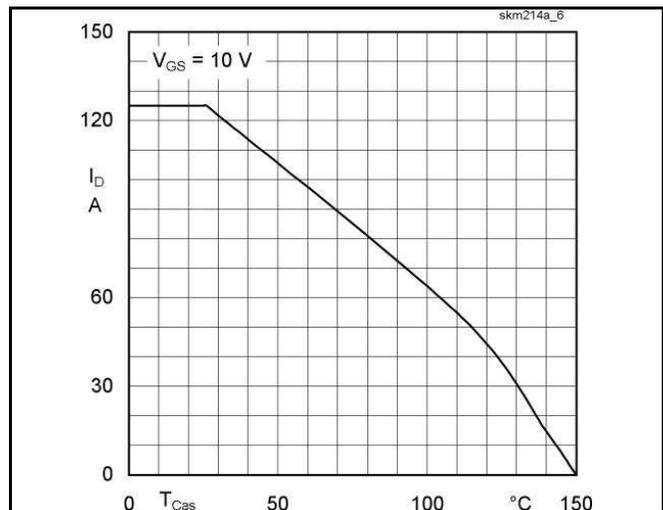


Fig. 6 Rated current vs. temperature

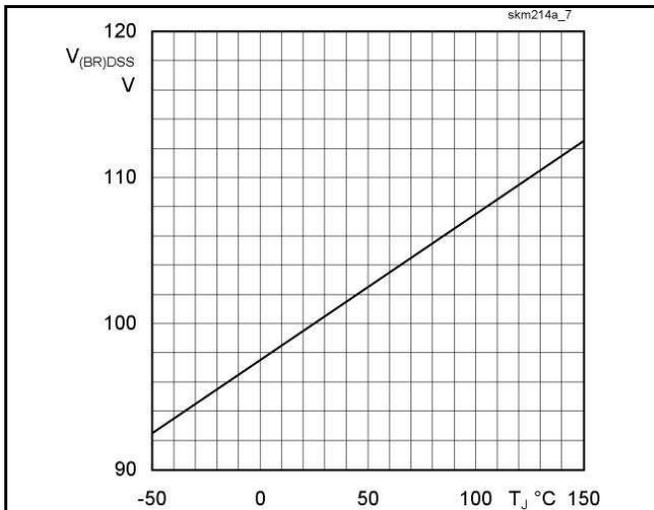


Fig. 7 Breakdown voltage vs. temperature

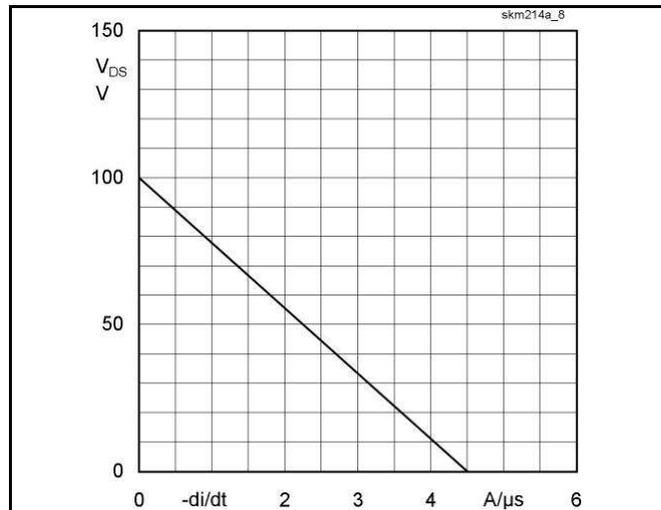


Fig. 8 Drain-source voltage derating

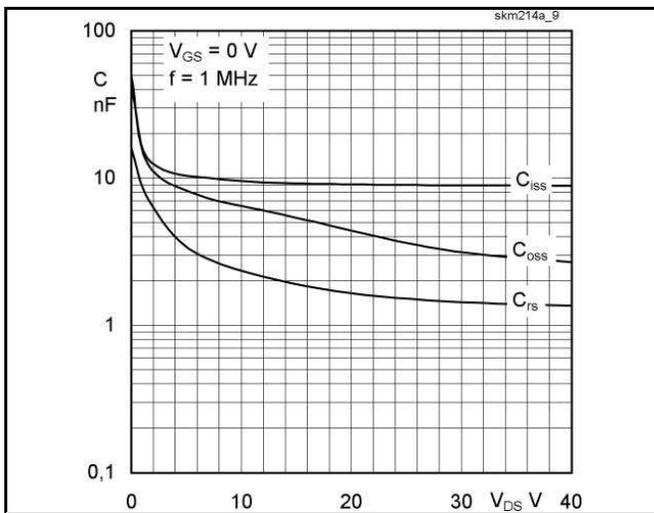


Fig. 9 Capacitances vs. drain-source voltage

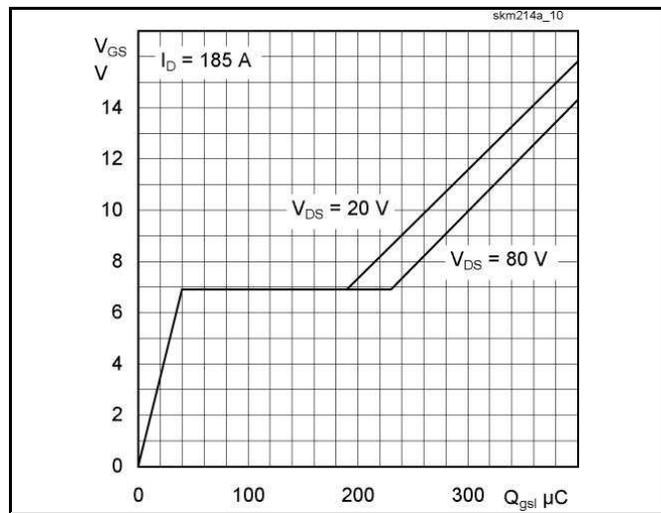


Fig. 10 Gate charge characteristic

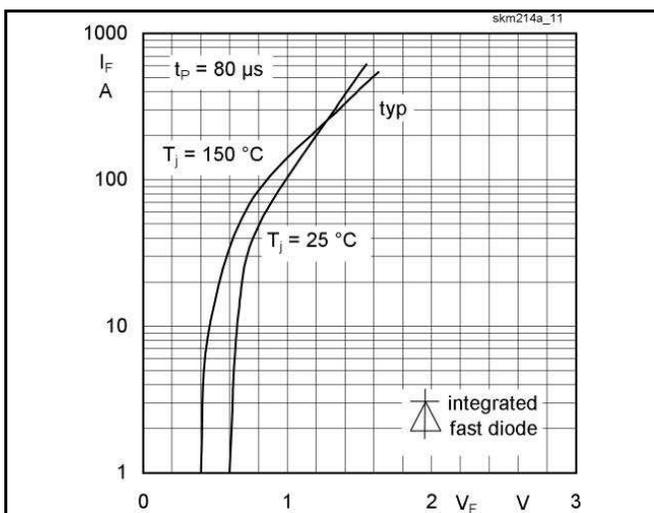


Fig. 11 Diode forward characteristic

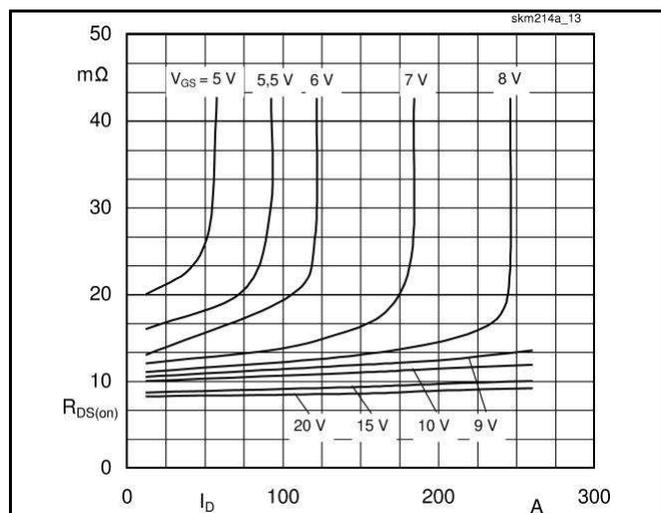


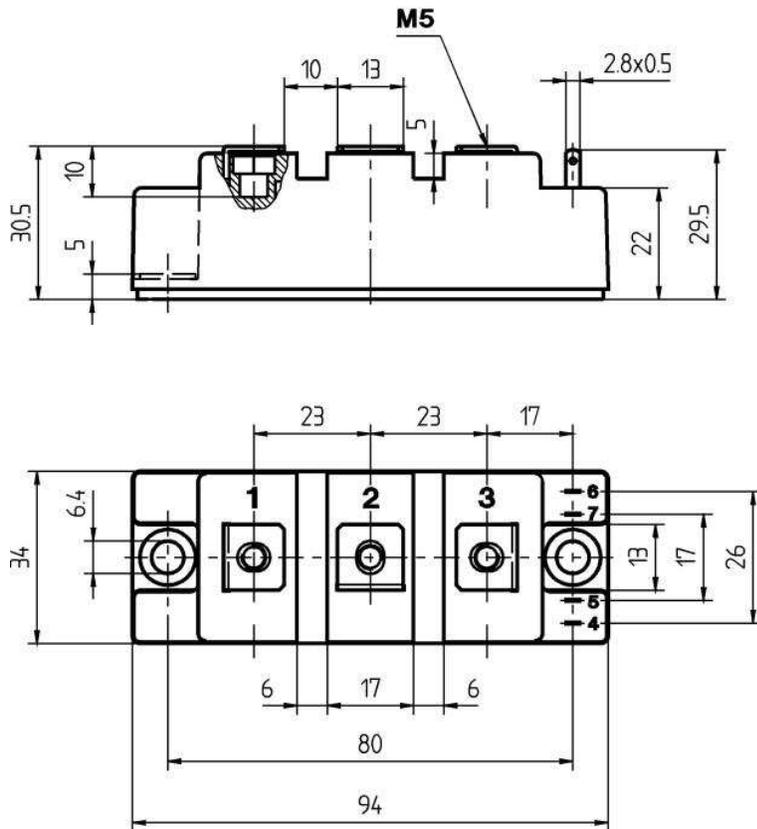
Fig. 13 On-resistance vs. drain current

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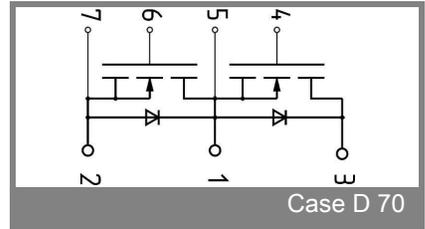
UL Recognized  
File no. E 63 532

Dimensions in mm

CASED70



Case D 70



Case D 70

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.